

## The ATLAS High Granularity Timing Detector





# **HGTD Motivation**

- LHC will be upgraded in 2024-2026 to High Luminosity LHC (HL-LHC)
  - Instantaneous luminosities up to  $L \simeq 7.5 \times 10^{34} cm^{-2} s^{-1}$  about 5 times the current
  - Pile up  $<\mu>\simeq 200$  simultaneous interactions per bunch crossing
  - On average 1.5 vertex/mm along beam line att collision point



 In the forward region the tracker (new ATLAS tracker ITK) has less longitudinal resolution → degraded vertex resolution



# **HGTD Motivation**

- A new layer of silicon detectors with precise timing, High Granularity Timing Detector (HGTD), in front of the liquid argon end-cap calorimeters improves performance by combining
  - HGTD precise timing
  - ITK position information





# **HGTD Requirements**

- Two endcap disks at z = ±3.5 m
- 6.3m<sup>2</sup> active rea: 120mm<R<640mm</li>
  ⇒ 2.4 < |η| < 4.0</li>
- Time resolution better than 30 ps per track (50 ps per hit in a 2 layer geometry)
- Sensors on both sides of two cooling plates with varying overlap ⇒
   <nhits>=3 for R<320mm (80% overlap)</li>

 $\langle n_{hits} \rangle = 2 \text{ for } R < 320 \text{ mm} (80\% \text{ overlap})$ 

- Requirement of occupancy < 10%</li>
  ⇒ 1.3 mm × 1.3 mm pixels
- 15x30 pixel sensors
- Sensors bump bonded to readout ASIC (ALTIROC) (15x15 chip)
- Wire bonded to flex cable
- Intotal 3.59 M channels



ASIC wire bonding

\*Not to scale



- Total fluence (n<sub>eq</sub>) and dose to be sustained (new updated numbers compared to fig):
  - + R < 32 cm  $\rightarrow~5.1{\times}10^{15}\,n_{eq}/cm^2$  and 4.7 MGy
  - + R > 32~cm  $\rightarrow$   $3.9 \times 10^{15}\,n_{eq}/cm^2$  and 1.9 MGy
- A safety factor 1.5 for n<sub>eq</sub> (sensor) and 2.25 for dose (ASIC) and replacement of inner wheel < 32 cm) (~32% of sensors and ASICs) at mid run of HL-LHC are taken into account





# **HGTD sensors: LGADs**



R&D program to provide sensors with required time resolution, radiation hardness and fine segmentation

- New doping materials, substrates and geometries
- Prototypes tested from CNM, HPK, BNL, FBK
- >1000 single pad sensors tested
- Several 5x5 and 15x15 sensors tested. Very uniform leakage current and breakdown voltage

### Low Gain Avalanche Detectors (LGADs)

- n-on-p planar silicon layer with additional p-layer for moderate gain (10-50) (increases signal, limits noise)
- Time resolution < 30 ps before irradiation
- Thin (base line 50 $\mu$ m) => small  $t_{rise}$





## **Contributions to timing resolution**

$$\sigma_{timing}^2 = \sigma_{Landau}^2 + \sigma_{jitter}^2 + \sigma_{time \ walk}^2 + \sigma_{TDC}^2 + \sigma_{clock}^2$$

- Landau term: < 25 ps, reduced for thin lacksquaresensors (35-50  $\mu$ m) Jitter term  $\sigma_{jitter} pprox rac{t_{rise}}{S/N}$ Edge Time walk, minimised by correcting < 25 ps Threshold Discriminator for time over threshold (or for beam tests using constant fraction Time discriminator (CFD)) Time given by the Time Walk CFD 50%, no time walk Digitisation granularity ~ 5ps
  - Clock distribution < 10 ps



## **Radiation damage on LGADs**

- Sensors have been irradiated at with neutrons at IJS (Lubiana) and protons at PS-IRRAD (CERN):
  - From  $1 \times 10^{14}$  to  $1 \times 10^{16}$  n<sub>eq</sub>/cm<sup>2</sup> (3.7×10<sup>15</sup> n<sub>eq</sub>/cm<sup>2</sup> need for HGTD)
- Reduction of gain partially compensated by increasing bias voltage (higher breakdown voltage)





Z. Galloway et al, arXiv:1707:04961 and Y. Zhao et al arXiv: 1803:02690



### **Test beam measurements**

Hit efficiency and timing resolution has been studied with pion beams at CERN SPS North Area

- $\sim$  50 sensors tested so far
- Un-irradiated sensors CNM, HPK, BNL
- Irradiated sensors (neutron & proton) CNM and HPK
- 2×2 array sensors
- 2×2 array sensors with ALTIROC0\_v2
- Arrays with different inter-pad gaps



Beam tests have also been performed at Fermilab and SLAC and in future also DESY



**Hit efficiency** 

#### Before irradiation

After  $6 \times 10^{14} n_{eq}/cm^2$ 





### **Timing resolution**

A SiPM is used as time reference. Its 40 ps contribution is subtracted.

### Before irradiation

After  $6 \times 10^{14} n_{eq}/cm^2$ 





### **Results from test beam measurements**

#### Signal efficiency in the interpad region

as function of X (mm) for 3 different voltage thresholds

### Before irradiation

After  $6 \times 10^{14} n_{eq}/cm^2$ 





## **ALTIROC Readout ASIC**

ATLAS LGAD Timing Integrated ReadOut Chip (ALTIROC)

- Broad band voltage pre-amplifier
  - Input transistor size chosen to minimize noise and power consumption
  - Provide TOA (9 bits, 20 ps bins) and ToT (7 bits, 40 ps bins)
  - Rise time ~0.5-1 ns (as sensor) to minimise jitter
  - Designed for 5  $\mu$ A sensor leakage current



Bunch by bunch luminosity measurement capability

- Sums hits in two time windows to evaluate luminosity and background per ASIC
- Only ASICS at R> 320 mm will use luminosity readout



R2= 15K or 25K

Id1 200 uA

R1= 4K

Vcasc

Vin

M3

Vout pa



### **ALTIROC Readout ASIC**



Developed in phases:

- ALTIROC0: single pixel analog readout (pre-amp + discri)
  - test bench measurements satisfactory
  - Beam tests  $\rightarrow$  see next slides
- ALTIROC1: full single pixel (analog + TDC) readout in 5×5 array
  - Test bench measurements on-going (preliminary results show similar behaviour as ALTIROC0)
  - Irradiation and beam tests in Q1 2019
- ALTIROC2: final 15x15 version.
  - Submission expected end 2019



- ALTIROC0\_v2 bump bonded to an un-irradiated CNM 2×2 LGAD array
  - TOA of signal corrected for time walk (using probe amplitude)
- Best achieved time resolution after correction: 35 ps





## **Summary and perspectives**

- The HGTD will mitigate pile-up effects and improve performance in the ATLAS forward region
- Technical proposal was approved 2018
- After a fluence of 6×10<sup>14</sup> n<sub>eq</sub>/cm<sup>2</sup>
  - Efficiency in bulk is still ~100%
  - Time resolution of 40-50 ps is achieved Link to HGTD beam test paper
- Intense R&D program during 2019-2020
- New sensors are under tests, including 5x5 and 15x5 arrays
- Technical Design Report (TDR) under preparation (5 April)





## **Backup: HGTD Schedule**





### Backup







2x2 Pad Array







### **Backup: Pile-up rejection**



 Pileup-jet rejection as a function of hard-scatter jet efficiency in forward region

 No HGTD (black) and HGTD with different σ(t)

With initial and final timing resolution ( $\sigma(t) = 30$  ps), rejection improved by factor of 1.6-4



### **Backup: Pile-up rejection**



Fixed pileup-jet eff of 2%, HS eff vs  $\eta$ 



### **Backup**



Time resolution worsens with radiation (higher dose at lower radius) Compensated by more hits/track at lower radius. ( $\geq$  3 hits at R<320 mm, $\geq$ 2 hits at > R)



#### **Examples:**







- Light-jet rejection versus *b*-jet efficiency within the HGTD acceptance  $\rightarrow$
- At 70% WP, light-jet rejection improved by a factor of ~1.6

Particularly useful for physics with reducible bg from mis-tagged light jets!







- Light-jet rejection versus *b*-jet efficiency within the HGTD acceptance  $\rightarrow$
- At 70% WP, light-jet rejection improved by a factor of ~1.6
- ▶ At high  $\eta$  rej. improved by factor  $\sim$ 3

Particularly useful for physics with reducible bg from mis-tagged light jets!







- Efficiency for electron isolation selection as a function of pileup vertex density
- No HGTD (black) and HGTD with different σ(t) scenarios
- HGTD removes the majority of the effects of pileup, recovers 15% for average HL-LHC vertex density
- ▶  $\sigma(t) < 30$  ps does not help much



#### Physics: Impact on tH (final state with $\geq 2 b$ -tagged jets)



 $|\eta|$  for most forward light-jet shown in the 3b region for tH followed by  $H\to b\bar{b}$  and the backgrounds from  $t\bar{t}$  and  $t\bar{t}H$  production

• Probes sign of top-Yukawa coupling directly (left, if negative  $\Rightarrow \sigma(tH) \times 10$ ), complementary to  $t\bar{t}H$ 



- Sensitivity to tH increased by 11% using HGTD
- Primarily due to improved b-tagging